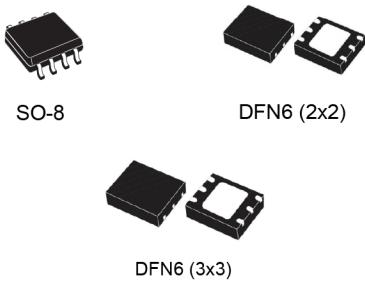


High PSRR, low drop linear regulator IC



Features

- Input voltage from 2.5 V to 18 V
- 20 V AMR
- Any fixed output voltages, from 1.2 V to 12 V in 100 mV steps (from 1.2 V to 6.6 V in 50 mV steps) available on request
- Adjustable version from 1.18 V to $V_{IN} - V_{DROP(MAX)}$
- Guaranteed output current 1.2 A
- Typical dropout 350 mV @ 1.2 A
- Undervoltage lockout
- Enable function
- Internal thermal, current and power limitation
- High PSRR: 87 dB @ 120 Hz, 75 dB @ 1 kHz
- Operating temperature range: -40 °C to 125 °C
- Packages SO-8 batwing plastic micropackage, DFN6 (3x3) and DFN6 (2x2)

Applications

- Consumer
- Industrial
- SMPS
- Point-of-load
- DC-DC post-regulation

Maturity status link

LDL212

Description

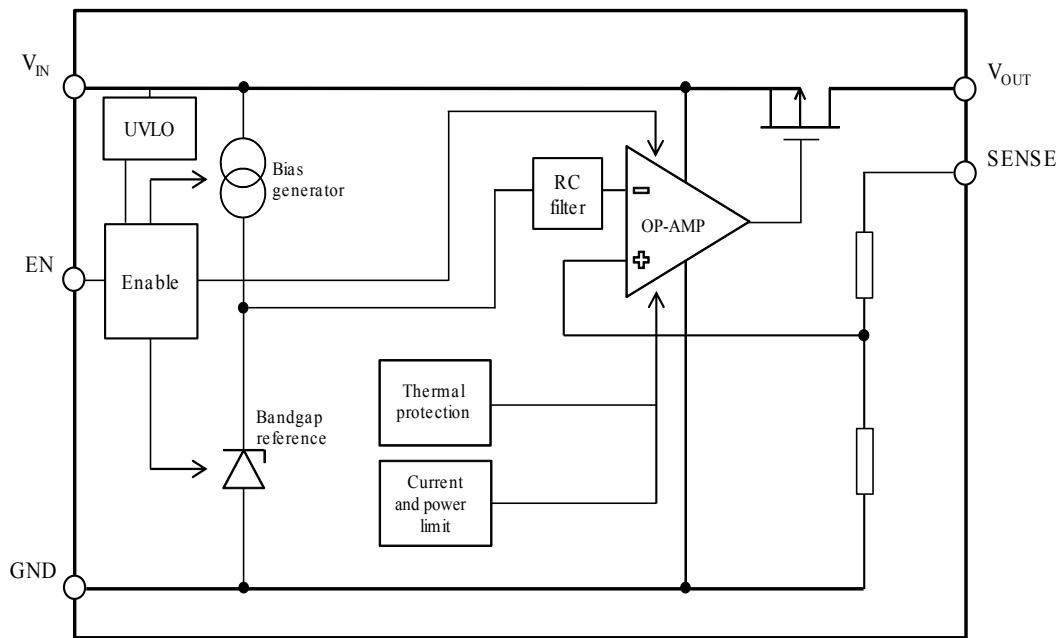
The [LDL212](#) provides 1.2 A of maximum current from an input voltage range from 2.5 V to 18 V, with a typical dropout voltage of 350 mV @ 1.2 A.

The high power supply rejection ratio of 87 dB at 120 Hz, and more than 40 dB at 100 kHz, makes the [LDL212](#) suitable for direct regulation in SMPS and secondary linear regulation in DC-DC converters. The [LDL212](#) goes to shutdown mode due to the enable logic control function, reducing the total current consumption.

The device also includes the current limit, SOA and thermal protections.

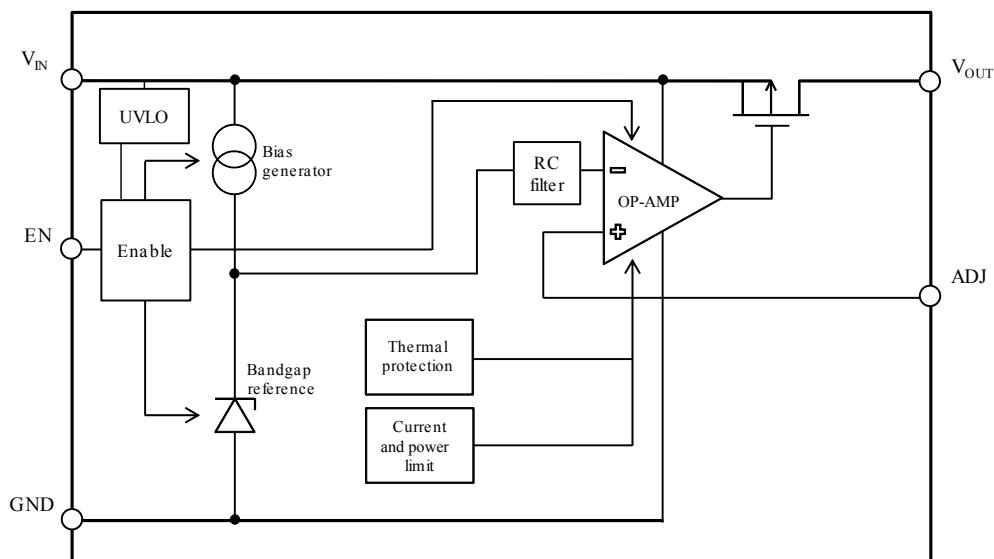
1 Block diagram

Figure 1. Block diagram (fixed)



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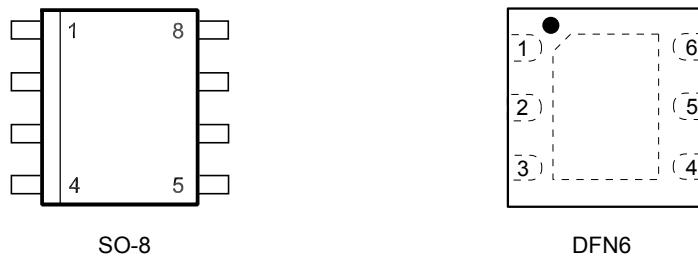
Figure 2. Block diagram (adjustable)



GIPD251120151438bMT

2 Pin configuration

Figure 3. Pin configuration (top view)



GIPD261120151015MT

Table 1. Pin description

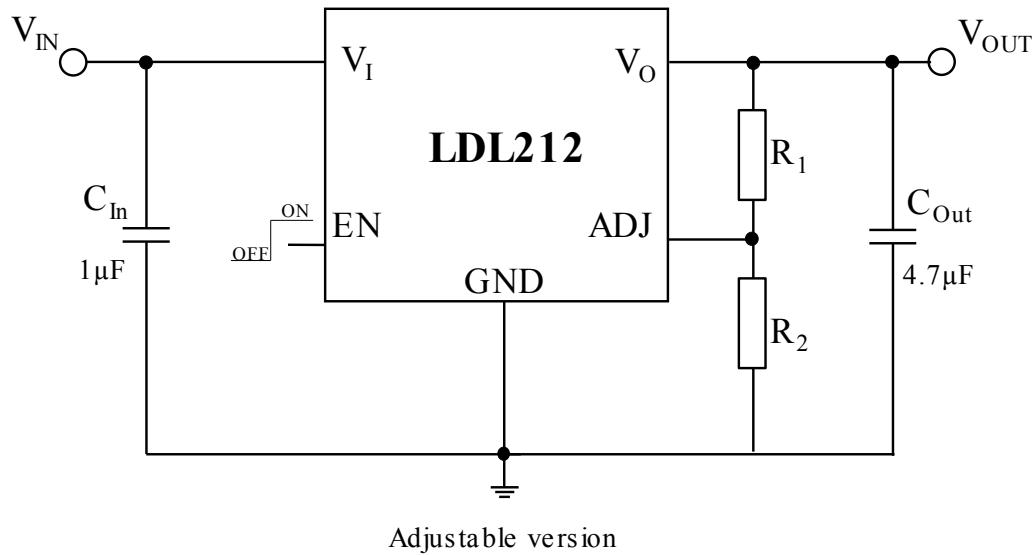
Pin name	Pin number (SO-8)	Pin number (DFN6)	Description
V _{IN}	4	4	Input voltage
V _{OUT}	1	3	Output voltage
GND	2, 3, 6, 7	1	Output voltage
ADJ/sense	8	2	Feedback pin for adjustable version / V _{OUT} sense on fixed version
EN	5	6	Enable pin. The device is in off-state when this pin is pulled low
NC	-	5	Not connected
GND	-	exposed pad	Exposed pad must be connected to GND

1. The sense pin on the fixed version must be connected to V_{OUT} for proper operation.

3

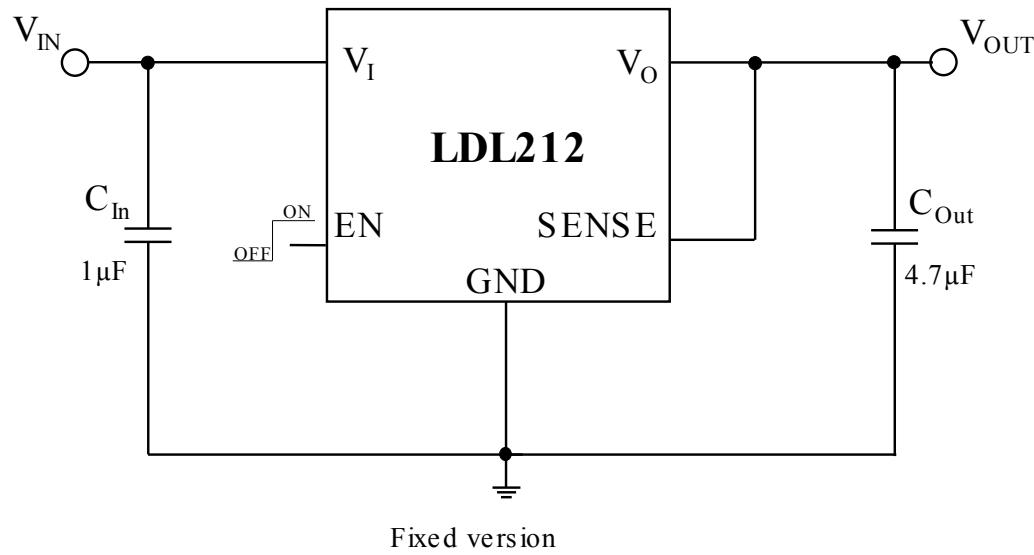
Typical application

Figure 4. Typical application circuit (adjustable version)



GIPD011220151346MT

Figure 5. Typical application circuit (fixed version)



GIPD011220151347MT

Note:

R₁ and R₂ are calculated according to the following formula: R₁ = R₂ x (V_{OUT}/V_{ADJ} - 1). The output voltage of the adjustable version can be set from 1.18 V to V_{IN}-V_{DROP(MAX)}, where V_{DROP(MAX)} is the maximum dropout voltage, as defined in Table 4. Electrical characteristics.

4 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{IN}	DC input voltage	- 0.3 to 20	V
V_{OUT}	DC output voltage	- 0.3 to $V_{IN} + 0.3$	V
V_{EN}	Enable input voltage	- 0.3 to $V_{IN} + 0.3$	V
V_{SENSE}	Output sense pin voltage	- 0.3 to $V_{IN} + 0.3$	V
V_{ADJ}	ADJ pin voltage	- 0.3 to 2	V
I_{OUT}	Output current	Internally limited	mA
P_D	Power dissipation	Internally limited	mW
T_{STG}	Storage temperature range	- 55 to 150	°C
T_{OP}	Operating junction temperature range	- 40 to 125	°C

Note: *Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.*

Table 3. Thermal data

Symbol	Parameter	Value	Unit
SO-8 batwing plastic micropackage	Thermal resistance junction-to-case	20	°C/W
	Thermal resistance junction-to-ambient	55	
DFN6 (2x2)	Thermal resistance junction-to-case	15	°C/W
	Thermal resistance junction-to-ambient	65	
DFN6 (3x3)	Thermal resistance junction-to-case	10	°C/W
	Thermal resistance junction-to-ambient	55	

5 Electrical characteristics

$T_J = 25^\circ\text{C}$, $V_{IN} = V_{OUT(NOM)} + 1\text{ V}$, $C_{IN} = 1\text{ }\mu\text{F}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$, $I_{OUT} = 10\text{ mA}$, $V_{EN} = V_{IN}$, unless otherwise specified. (For $V_{OUT(NOM)} \leq 1.5\text{ V}$, $V_{IN} = 2.7\text{ V}$.)

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit		
V_{IN}	Operating input voltage		2.5		18	V		
V_{UVLO}	Turn-on threshold			2.3	2.4	V		
	Hysteresis		200			mV		
V_{OUT}	V_{OUT} accuracy	$I_{OUT} = 10\text{ mA}$	-2	2	%			
		$T_J = 25^\circ\text{C}$						
		$I_{OUT} = 10\text{ mA}$	-3	3	%			
		$-40^\circ\text{C} < T_J < 125^\circ\text{C}$						
V_{ADJ}	Adjustable pin voltage	$V_{IN} = 2.5\text{ V}$, $I_{OUT} = 10\text{ mA}$		1.18		V		
		$T_J = 25^\circ\text{C}$	-2		+2	%		
		$V_{IN} = 2.5\text{ V}$, $I_{OUT} = 10\text{ mA}$	-3	+3	%			
		$-40^\circ\text{C} < T_J < 125^\circ\text{C}$						
I_{ADJ}	Adjustable pin current	$V_{IN} = 2.5\text{ V}$, $I_{OUT} = 10\text{ mA}$		20		nA		
ΔV_{OUT}	Line regulation	$V_{OUT} + 1\text{ V} \leq V_{IN} \leq 18\text{ V}$, $I_{OUT} = 10\text{ mA}$		0.002	0.01	%/V		
ΔV_{OUT}	Load regulation	$I_{OUT} = 10\text{ mA}$ to 1.2 A		0.0001	0.0005	%/mA		
V_{DROP}	Dropout voltage ⁽¹⁾	$I_{OUT} = 1.2\text{ A}$ $V_{OUT} > 3\text{ V}$ $-40^\circ\text{C} < T_J < 125^\circ\text{C}$		350	600	mV		
eN	Output noise voltage	10 Hz to 100 kHz , $I_{OUT} = 100\text{ mA}$		60		$\mu\text{VRMS}/V_{OUT}$		
SVR	Supply voltage rejection	$V_{IN} = V_{OUT(NOM)} + 1\text{ V} \pm V_{RIPPLE}$	87		dB			
		$V_{RIPPLE} = 0.5\text{ V}$, $f = 120\text{ Hz}$						
		$V_{IN} = V_{OUT(NOM)} + 1\text{ V} \pm V_{RIPPLE}$	75					
		$V_{RIPPLE} = 0.5\text{ V}$, $f = 1\text{ kHz}$						
		$V_{IN} = V_{OUT(NOM)} + 1\text{ V} \pm V_{RIPPLE}$	50					
		$V_{RIPPLE} = 0.5\text{ V}$, $f = 100\text{ kHz}$						
I_Q	Quiescent current	$I_{OUT} = 0\text{ mA}$ to 1.2 A $-40^\circ\text{C} < T_J < 125^\circ\text{C}$		250	380	μA		
		V_{IN} input current in OFF mode	0.3	1.5				
		$V_{EN} = \text{GND}$ $V_{IN} = 18\text{ V}$						
I_{SC}	Short-circuit current	$R_L = 0$	1.5	2		A		

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{EN}	Enable input logic low	$V_{IN} = 2.5 \text{ V to } 18 \text{ V}$ $-40^\circ\text{C} < T_J < 85^\circ\text{C}$			0.4	V
	Enable input logic high	$V_{IN} = 2.5 \text{ V to } 18 \text{ V}$ $-40^\circ\text{C} < T_J < 85^\circ\text{C}$	1.2			
I_{EN}	Enable input current			1.5		μA
		$V_{EN} = V_{IN}, V_{IN} = 18 \text{ V}$		16	20	
T_{ON}	Turn-on time ⁽²⁾			120		μs
T_{SHDN}	Thermal shutdown			175		$^\circ\text{C}$
	Hysteresis			25		

1. Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification is not valid for output voltages below 2.2 V.
2. Turn-on time is the time measured between the enable input just exceeding V_{EN} high value and the output voltage just reaching 95% of its nominal value.

6

Typical performance characteristics

Figure 6. Output voltage vs. temperature ($V_{IN} = 2.5 \text{ V}$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 0 \text{ mA}$)

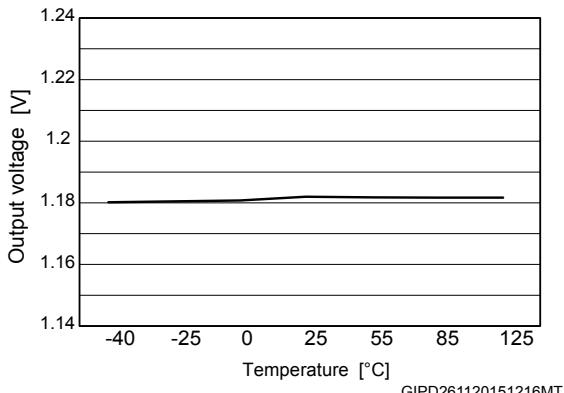


Figure 7. Output voltage vs. temperature ($V_{IN} = 2.5 \text{ V}$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 1200 \text{ mA}$)

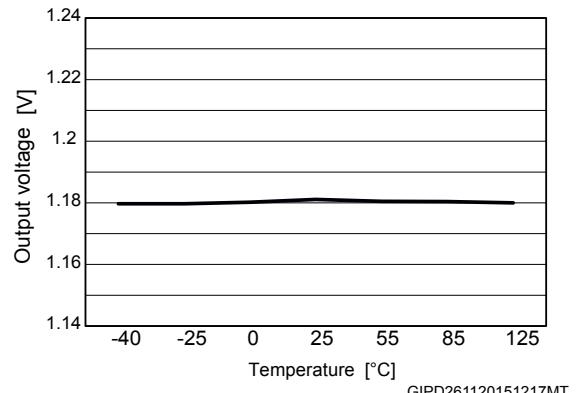


Figure 8. Output voltage vs. temperature ($V_{IN} = 6 \text{ V}$, $V_{OUT} = 5 \text{ V}$, $I_{OUT} = 10 \text{ mA}$)

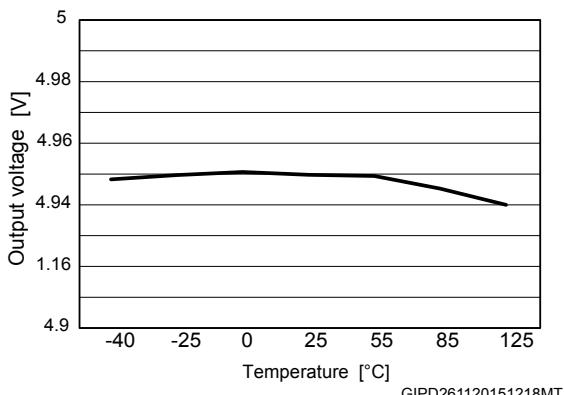


Figure 9. Output voltage vs. temperature ($V_{IN} = 6 \text{ V}$, $V_{OUT} = 5 \text{ V}$, $I_{OUT} = 1200 \text{ mA}$)

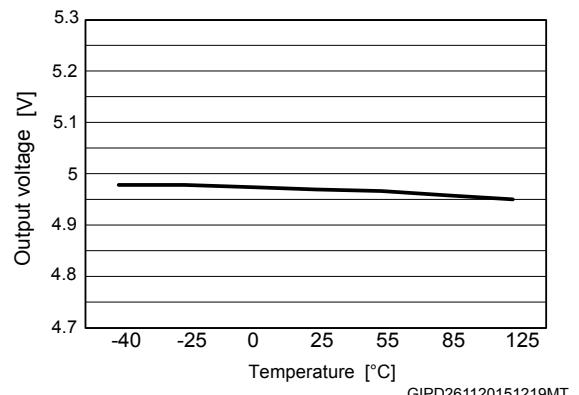


Figure 10. Line regulation vs. temperature ($V_{IN} = 6$ to 18 V, $V_{OUT} = 5$ V, $I_{OUT} = 10$ mA)

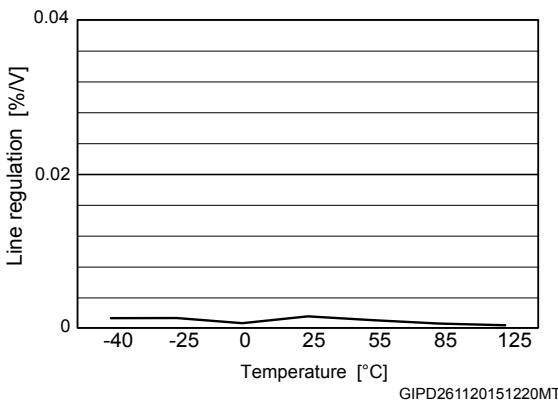


Figure 11. Line regulation vs. temperature ($V_{IN} = 2.5$ to 18 V, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 10$ mA)

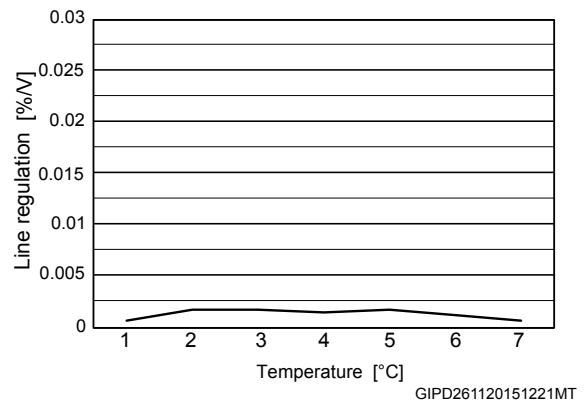


Figure 12. Load regulation vs. temperature ($V_{IN} = 6$ V, $V_{OUT} = 5$ V, $I_{OUT} = 10$ to 1200 mA)

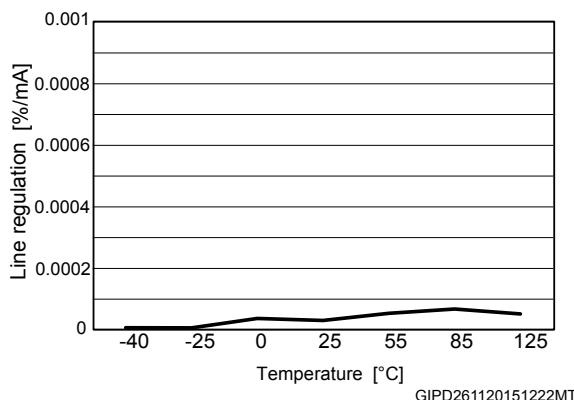


Figure 13. Load regulation vs. temperature ($V_{IN} = 2.5$ V, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 0$ to 1200 mA)

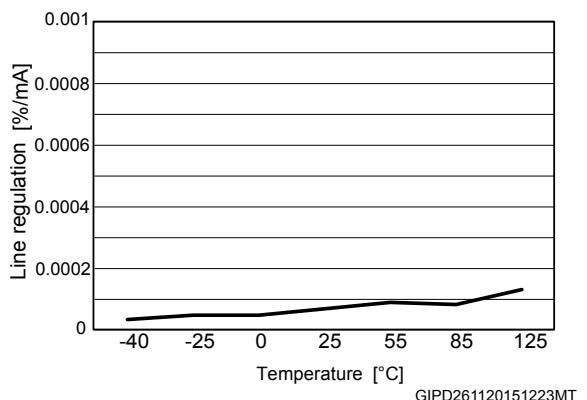


Figure 14. Enable thresholds vs. temperature ($V_{OUT} = V_{ADJ}$)

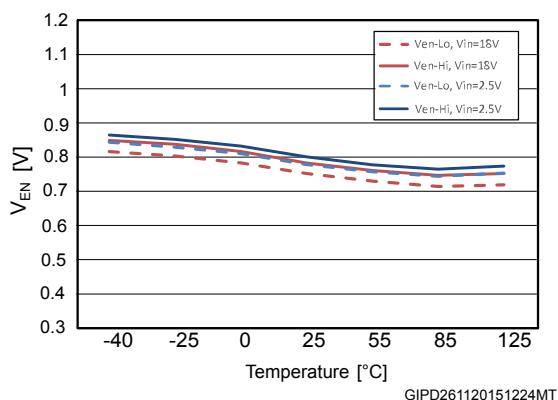


Figure 15. Enable thresholds vs. temperature($V_{OUT} = 5$ V)

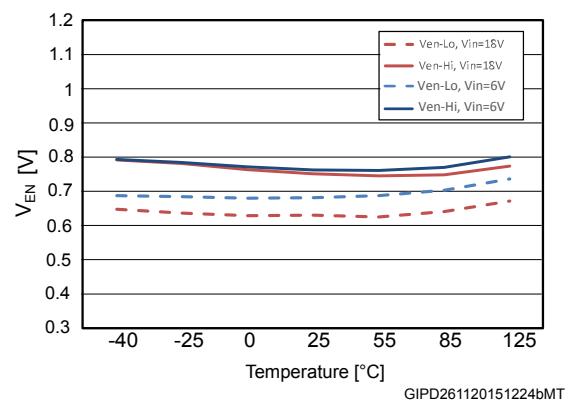
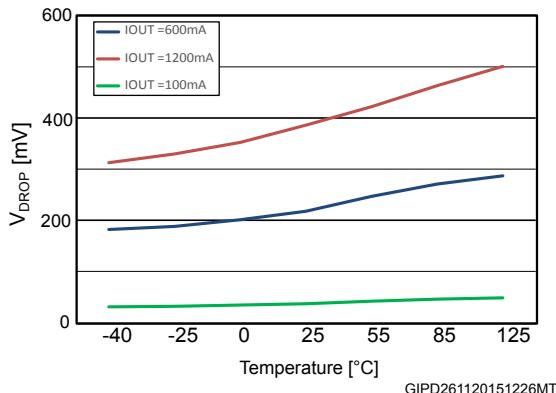
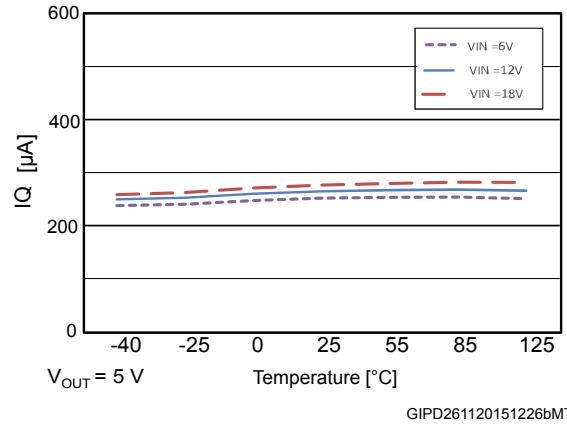
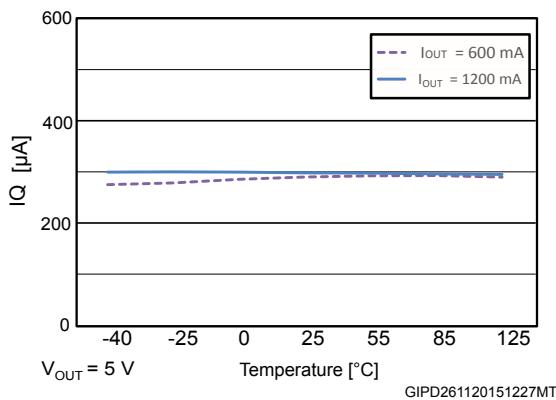
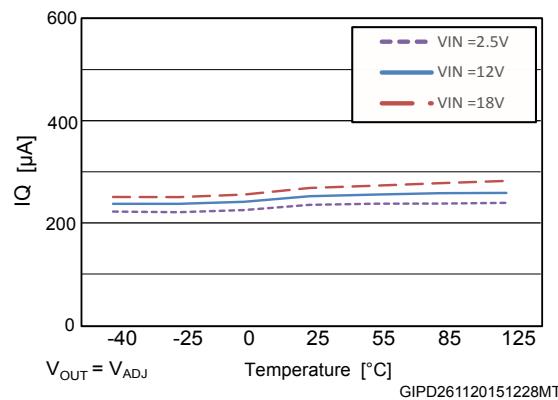
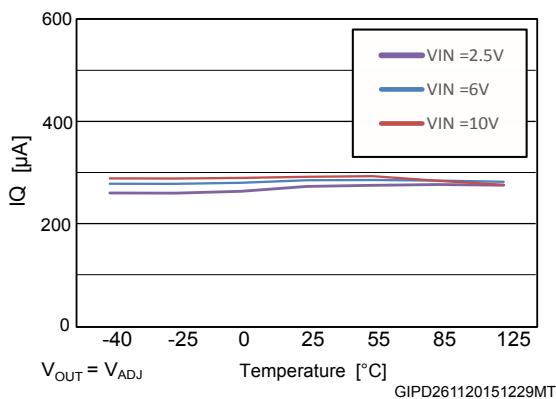
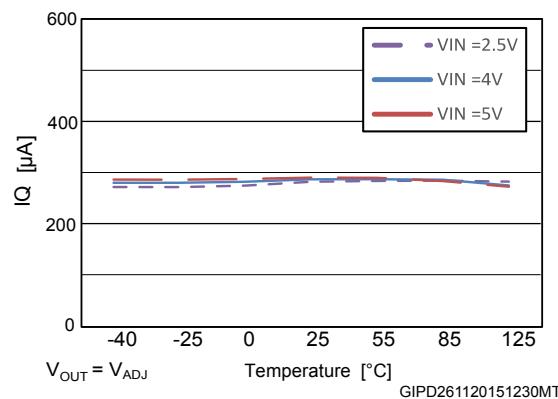
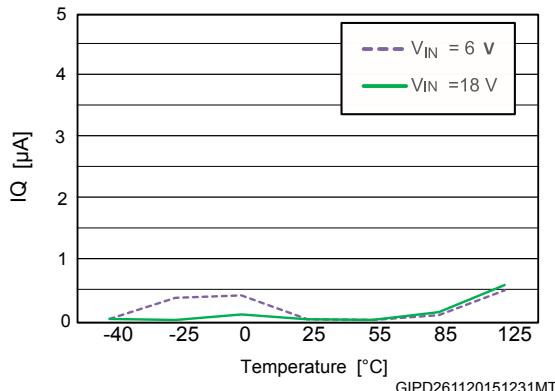
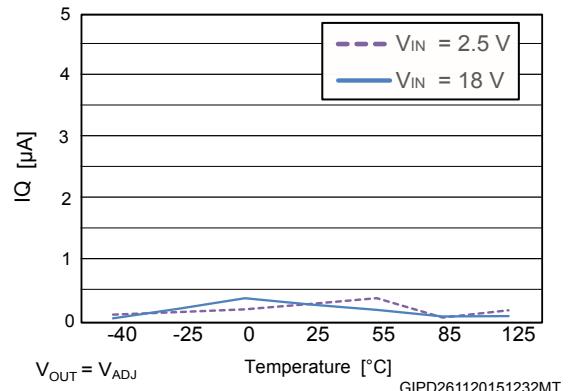


Figure 16. Dropout voltage vs. temperature**Figure 17. Quiescent current vs. temperature ($V_{OUT} = 5\text{ V}$, $I_{OUT} = 0\text{ mA}$)****Figure 18. Quiescent current vs. temperature ($V_{OUT} = 5\text{ V}$, $I_{OUT} = 600\text{ mA}$, 1.2 A)****Figure 19. Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 0\text{ mA}$)****Figure 20. Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 600\text{ mA}$)****Figure 21. Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 1.2\text{ A}$)**

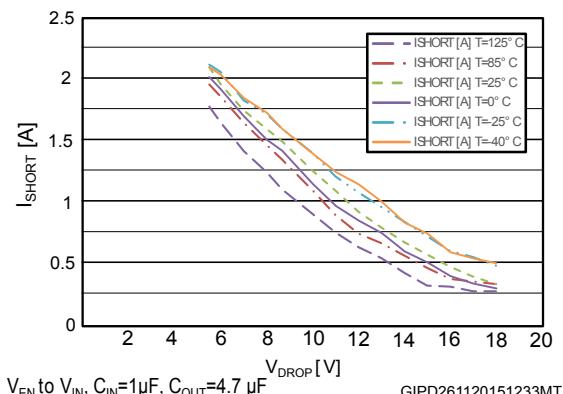
**Figure 22. Off-state current vs. temperature
($V_{OUT} = 5 V$)**



**Figure 23. Off-state current vs. temperature
($V_{OUT} = V_{ADJ}$)**



**Figure 24. Short-circuit current vs. dropout voltage
($V_{OUT} = 5 V$)**



**Figure 25. Short-circuit current vs. dropout voltage
($V_{OUT} = V_{ADJ}$)**

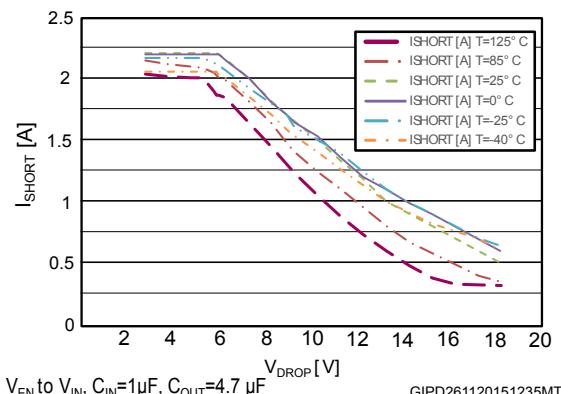
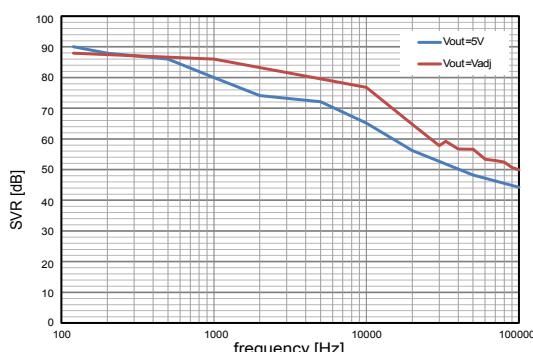


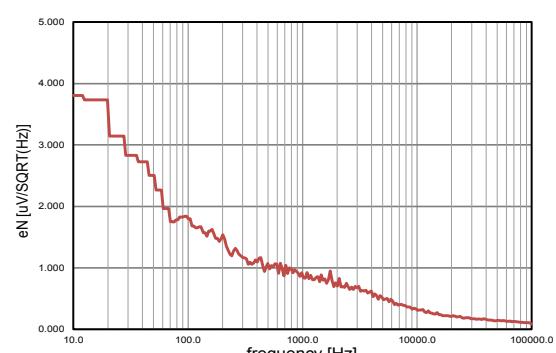
Figure 26. SVR vs. frequency



For $V_{OUT} = 5 V$, $V_{IN} = V_{EN}$ from 5.5 to 6.5V, $I_{OUT} = 10mA$, $C_{IN} = 1\mu F$, $C_{OUT} = 4.7\mu F$
For $V_{OUT} = V_{ADJ}$, $V_{IN} = V_{EN}$ from 2.5 to 3.5V, $I_{OUT} = 10mA$, No C_{IN} , $C_{OUT} = 4.7\mu F$

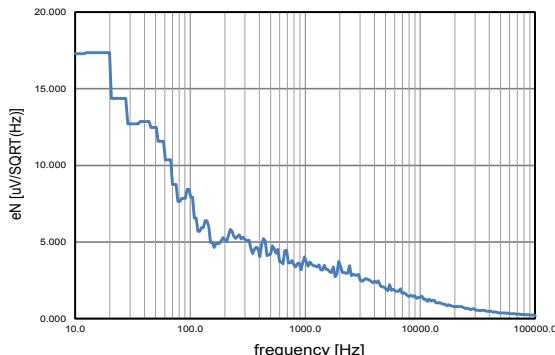
GIPD261120151236MT

**Figure 27. Output noise spectral density
($V_O = V_{ADJ}$)**

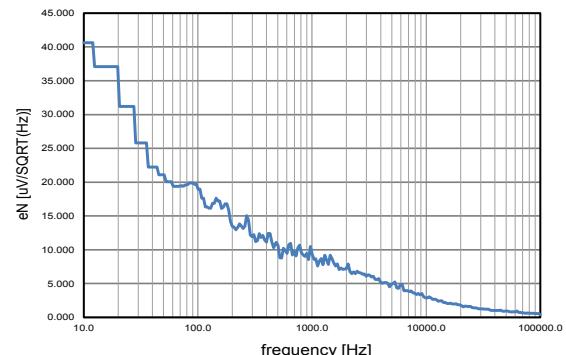


$V_{IN} = V_{EN} = 2.5V$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 100mA$, $C_{IN} = 1\mu F$, $C_{OUT} = 4.7\mu F$

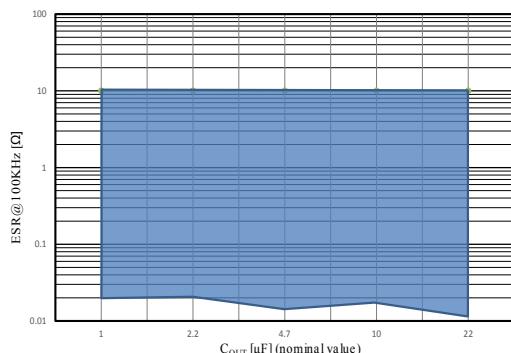
GIPD261120151237MT

Figure 28. Output noise spectral density ($V_O = 5 \text{ V}$)


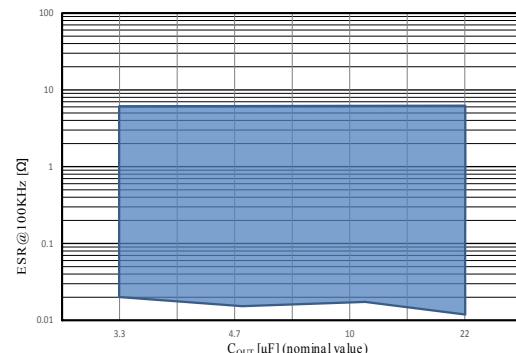
$V_{IN} = V_{EN} = 6\text{V}$, $V_{OUT} = 5\text{V}$, $I_{OUT} = 100\text{mA}$, $C_{IN} = 1\mu\text{F}$, $C_{OUT} = 4.7\mu\text{F}$
GIPD261120151238MT

Figure 29. Output noise spectral density ($V_O = 12 \text{ V}$)


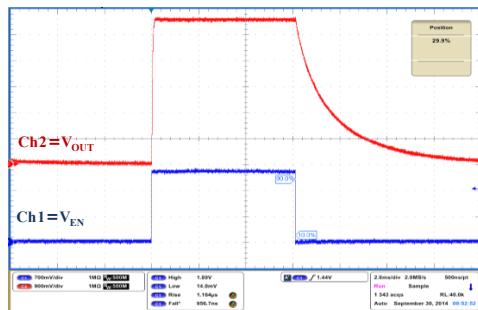
$V_{IN} = V_{EN} = 6\text{V}$, $V_{OUT} = 5\text{V}$, $I_{OUT} = 100\text{mA}$, $C_{IN} = 1\mu\text{F}$, $C_{OUT} = 4.7\mu\text{F}$
GIPD261120151239MT

Figure 30. Stability plan ($V_{OUT} = 5 \text{ V}$)


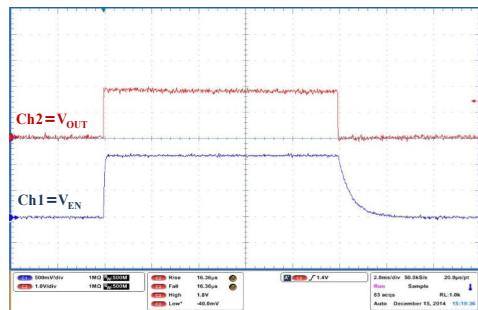
$V_{EN} = V_{IN}$ from 6 V to 18 V, I_{OUT} from 10 mA to 1.2 A
(according to Max I_{OUT} vs V_{drop} characteristics), $C_{IN} = 1\mu\text{F}$
GIPD301120151004MT

Figure 31. Stability plan ($V_{OUT} = V_{ADJ}$)


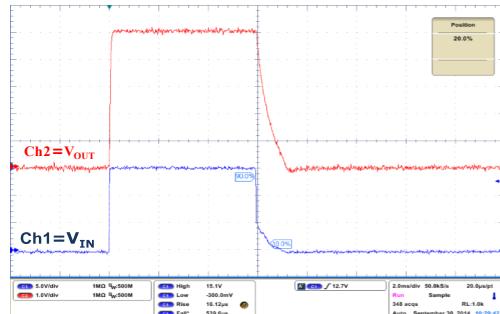
$V_{EN} = V_{IN}$ from 2.5 V to 18 V, I_{OUT} from 10 mA to 1.2 A
(according to Max I_{OUT} vs V_{drop} characteristics), $C_{IN} = 1\mu\text{F}$
GIPD301120151005MT

Figure 32. Startup with enable ($V_{OUT} = 5 \text{ V}$)


$V_{IN} = 15 \text{ V}$, V_{EN} from 0 to 2 V, $I_{OUT} = 10 \text{ mA}$ $C_{IN} = C_{OUT} = 1 \mu\text{F}$ $T_{rise} = 1 \mu\text{s}$
GIPD301120151405MT

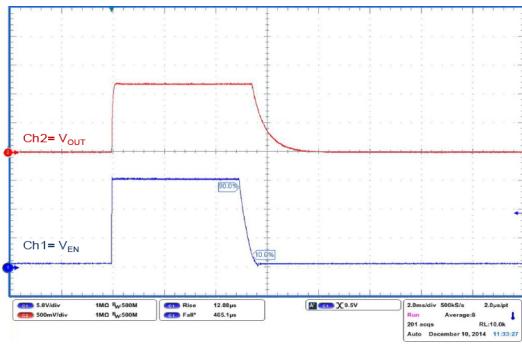
Figure 33. Startup with enable ($V_{OUT} = V_{ADJ}$)


$V_{IN} = 15 \text{ V}$, V_{EN} from 0 to 2 V, $I_{OUT} = 10 \text{ mA}$ $C_{IN} = C_{OUT} = 1 \mu\text{F}$ $T_{rise} = 1 \mu\text{s}$
GIPD301120151406MT

Figure 34. Turn-on time ($V_{OUT} = 5 V$)

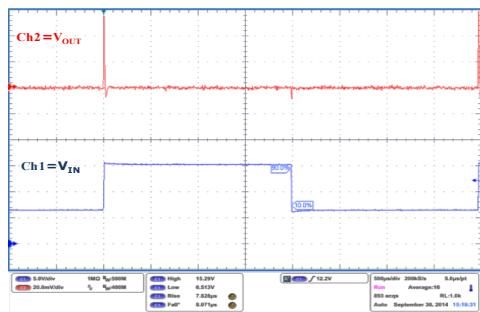
$V_{EN} = V_{IN}$ = from 0 to 15 V, $I_{OUT} = 10 \text{ mA}$, $C_{IN} = 1 \mu\text{F}$, $C_{OUT} = 4.7 \mu\text{F}$, $T_{rise} = 10 \mu\text{s}$

GIPD301120151407MT

Figure 35. Turn-on time ($V_{OUT} = V_{ADJ}$)

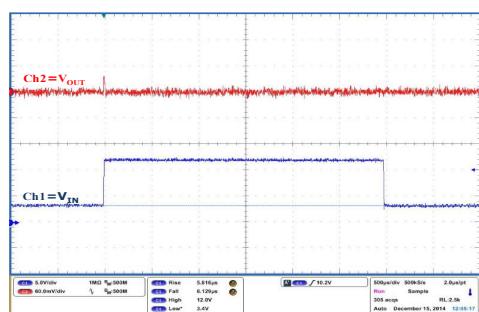
$V_{EN} = V_{IN}$ = from 0 to 15 V, $I_{OUT} = 10 \text{ mA}$, $C_{IN} = 1 \mu\text{F}$, $C_{OUT} = 4.7 \mu\text{F}$, $T_{rise} = 10 \mu\text{s}$

GIPD301120151408MT

Figure 36. Line transient ($V_{OUT} = 5 V$)

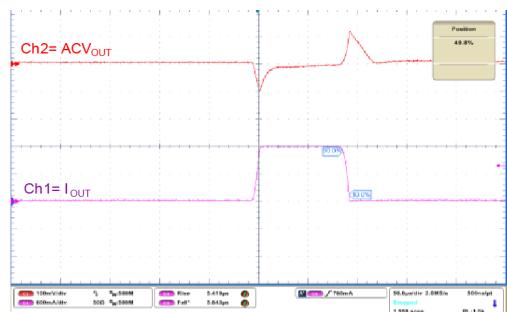
V_{IN} = from 6 to 15 V, $I_{OUT} = 10 \text{ mA}$, $C_{OUT} = 4.7 \mu\text{F}$, $t_r = 5 \mu\text{s}$

GIPD301120151409MT

Figure 37. Line transient ($V_{OUT} = V_{ADJ}$)

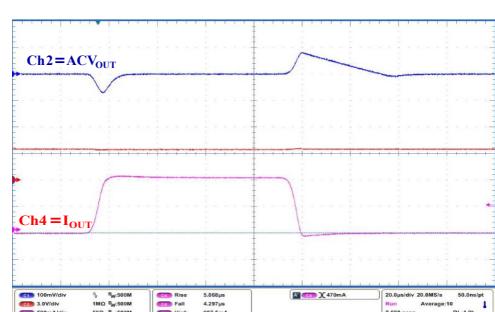
V_{IN} = from 3.5 to 15 V, $I_{OUT} = 10 \text{ mA}$, NO C_{IN} , $C_{OUT} = 4.7 \mu\text{F}$, $t_r = 5 \mu\text{s}$

GIPD301120151410MT

Figure 38. Load transient ($V_{OUT} = 5 V$)

V_{EN} to V_{CC} $V_{IN} = 6 \text{ V}$, I_{OUT} = from 10 mA to 1.2 A, $C_{IN} = 1 \mu\text{F}$, $C_{OUT} = 4.7 \mu\text{F}$, $T_{rise} = 5 \mu\text{s}$

GIPD301120151411MT

Figure 39. Load transient ($V_{OUT} = V_{ADJ}$)

V_{EN} to V_{CC} $V_{IN} = 3.5 \text{ V}$, I_{OUT} = from 10 mA to 1.2 A, $C_{IN} = 1 \mu\text{F}$, $C_{OUT} = 4.7 \mu\text{F}$, $T_{rise} = 5 \mu\text{s}$

GIPD301120151412MT

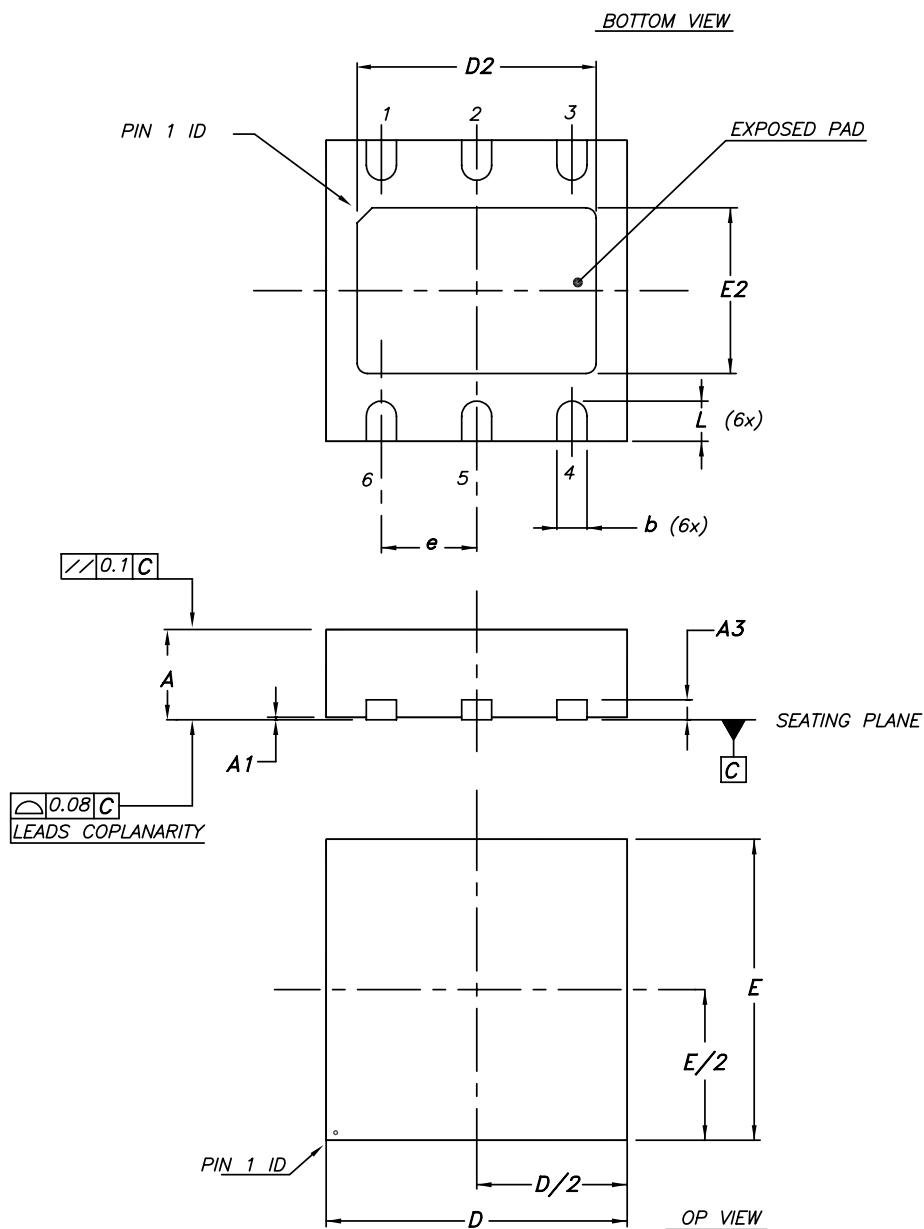
7

Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

7.1 DFN6 (3x3) package information

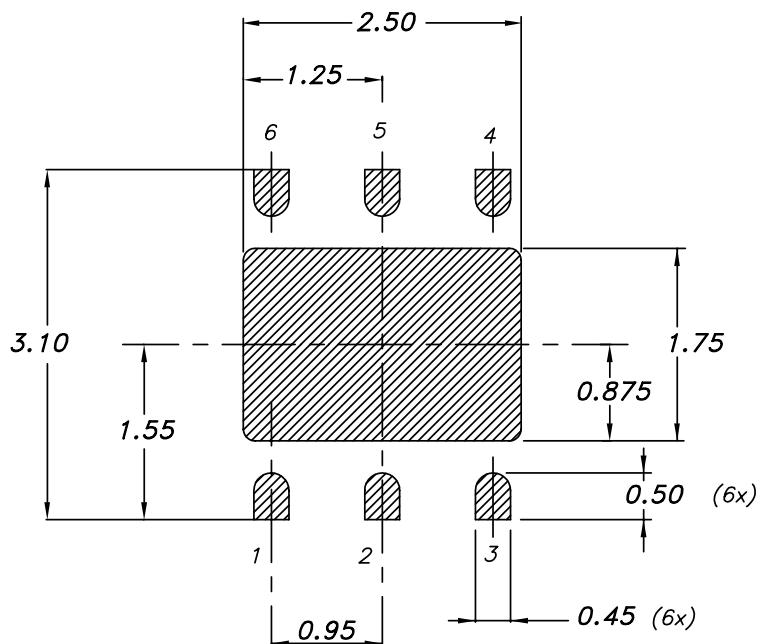
Figure 40. DFN6 (3x3) package outline



7946637_C

Table 5. DFN6 (3x3) mechanical data

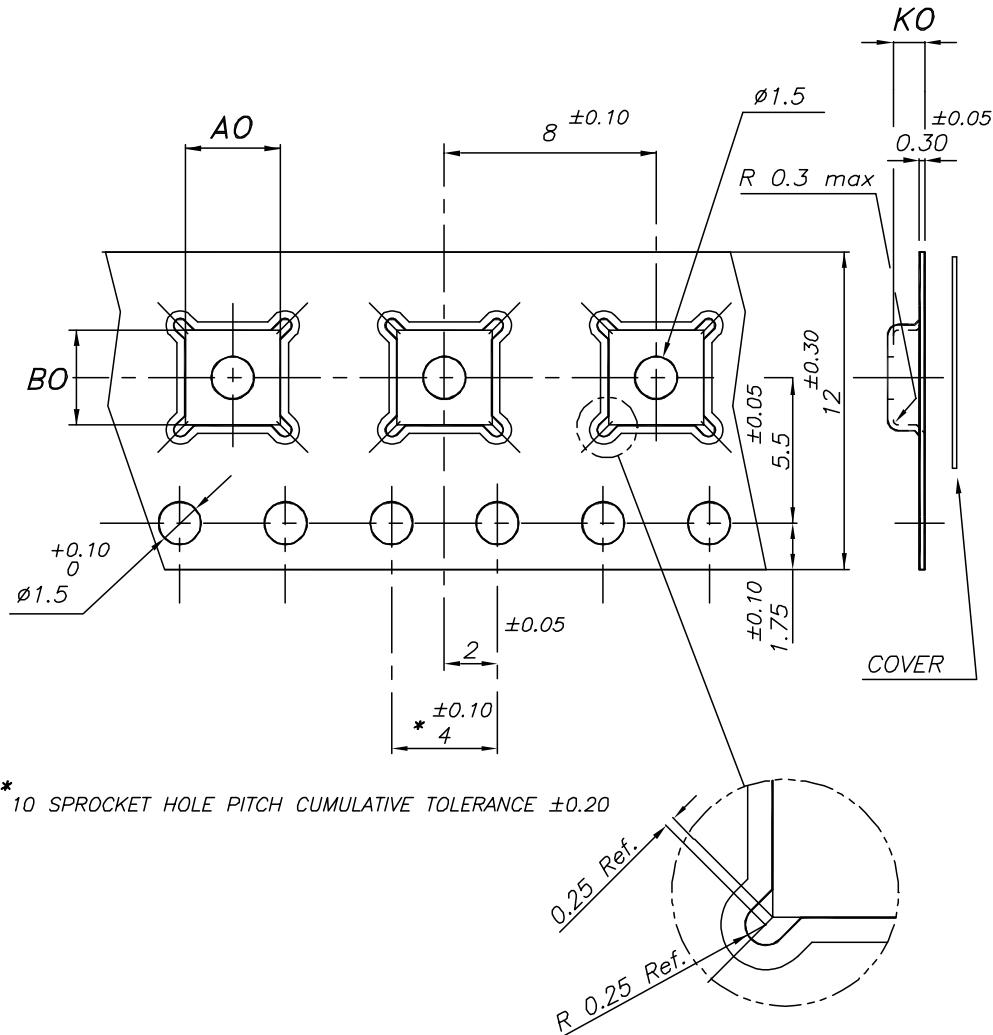
Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1
A1	0	0.02	0.05
A3		0.20	
b	0.23		0.45
D	2.90	3	3.10
D2	2.23		2.50
E	2.90	3	3.10
E2	1.50		1.75
e		0.95	
L	0.30	0.40	0.50

Figure 41. DFN6 (3x3) recommended footprint**FOOTPRINT RECOMMENDED**

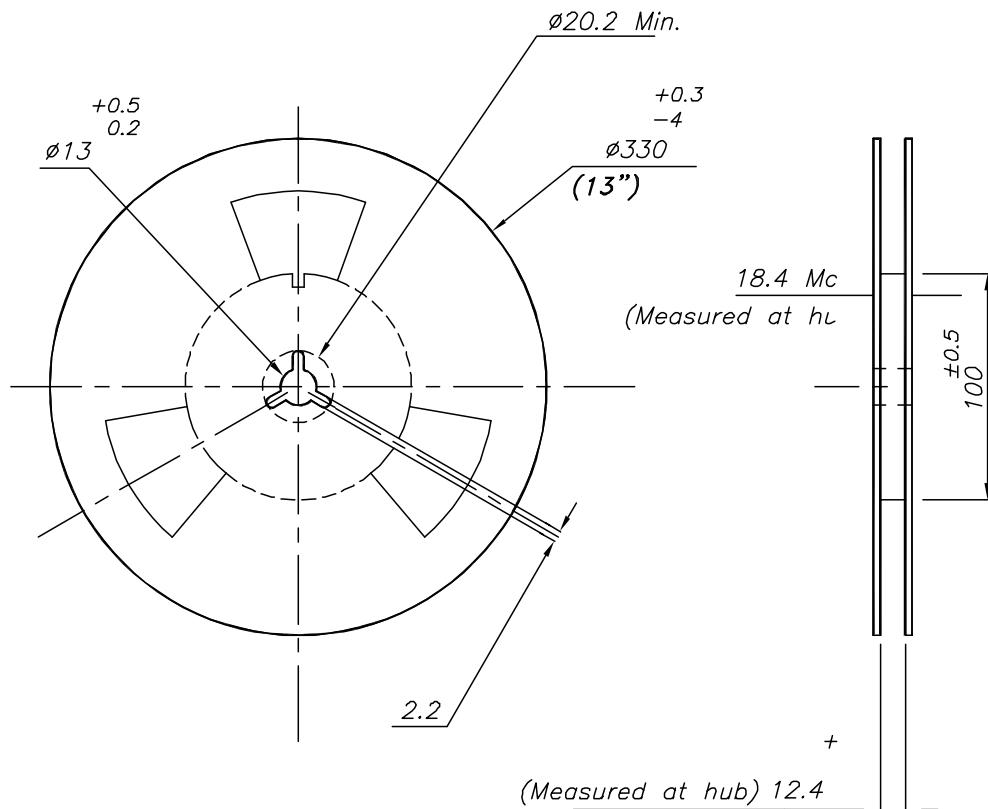
7946637_C

7.2 DFN6 (3x3) packing information

Figure 42. DFN6 (3x3) tape outline



7875978_N

Figure 43. DFN6 (3x3) reel outline

7875978_N

Table 6. DFN6 (3x3) tape and reel mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A0	3.20	3.30	3.40
B0	3.20	3.30	3.40
K0	1	1.10	1.20

7.3 DFN6 (2x2) package information

Figure 44. DFN6 (2x2) package outline

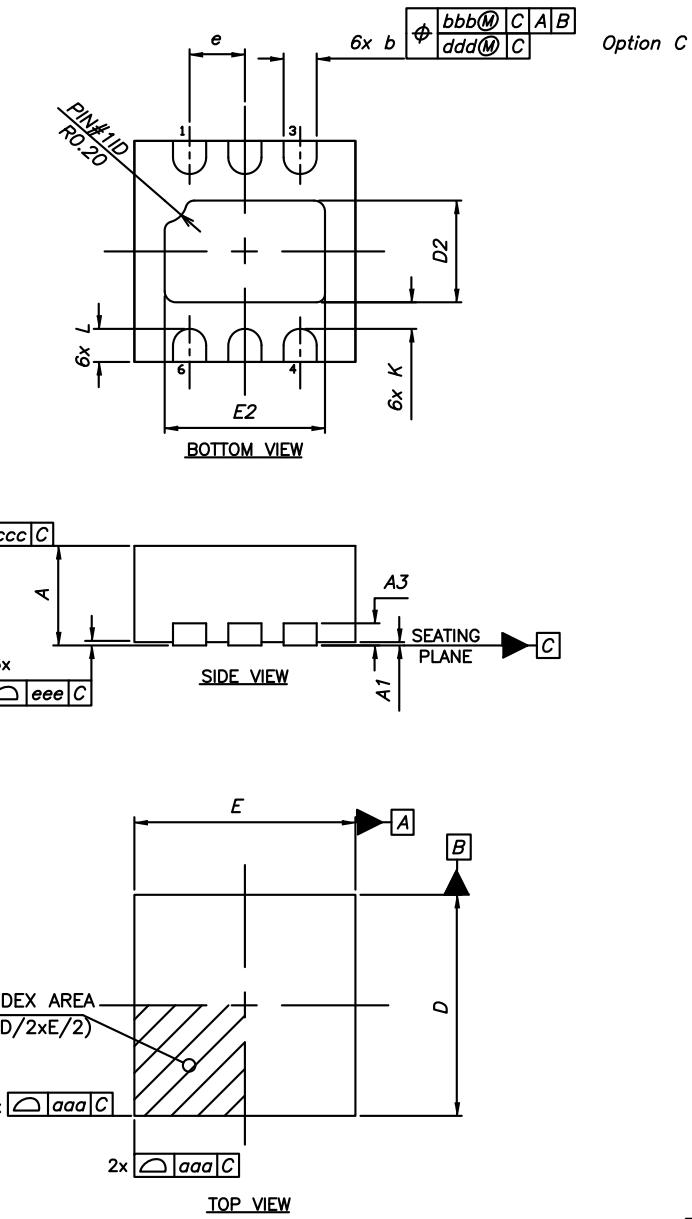
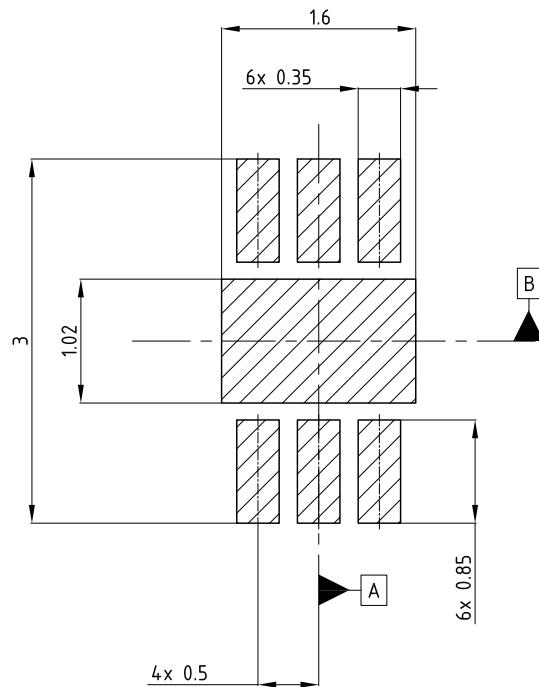


Table 7. DFN6 (2x2) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	-	0.203 ref	-
b	0.25	0.30	0.35

Dim.	mm		
	Min.	Typ.	Max.
D	-	2.00	-
E	-	2.00	-
e	-	0.50	-
D2	0.77	0.92	1.02
E2	1.30	1.45	1.55
K	0.15	-	-
L	0.20	0.30	0.40
aaa	-	0.05	-
bbb	-	0.10	-
ccc	-	0.10	-
ddd	-	0.05	-
eee	-	0.08	-

Figure 45. DFN6 (2x2) recommended footprint



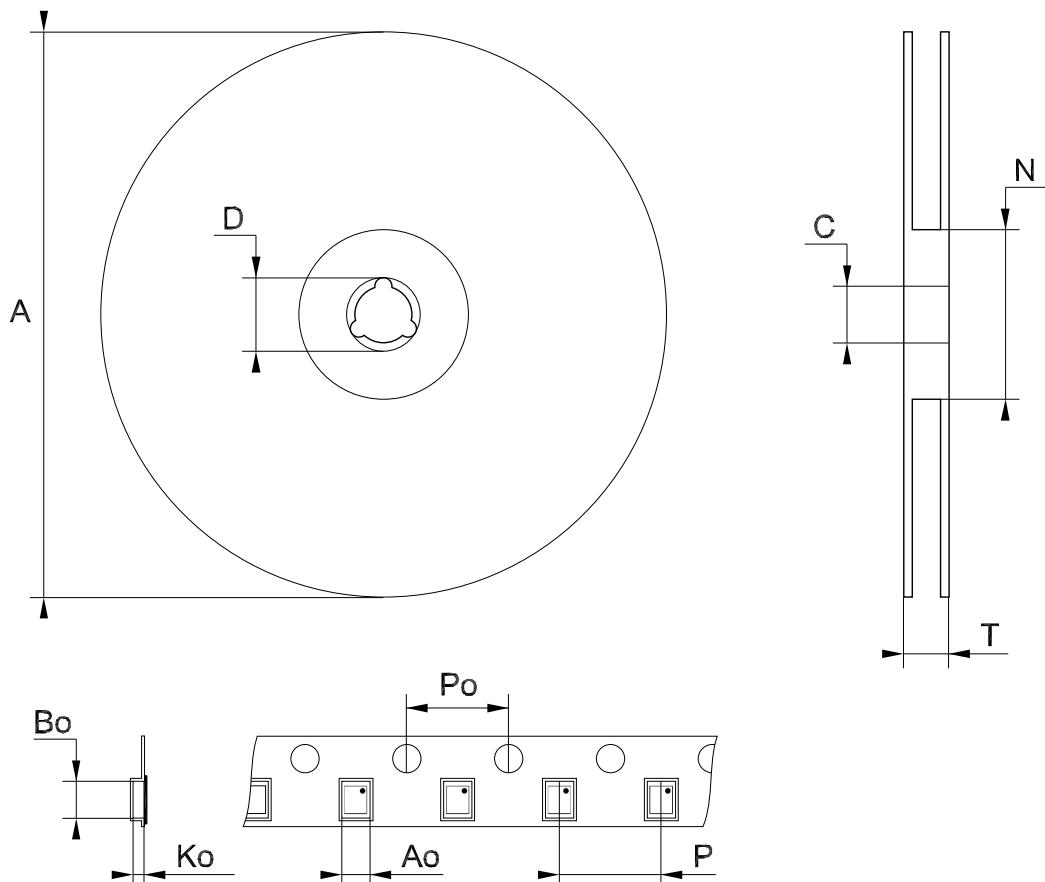
Notes:

- 1) This footprint is able to ensure insulation up to 32 Vrms (according to CEI IEC 664-1)
- 2) The device must be positioned within $\oplus | 0.02 | A | B |$

7733060 revE

7.4 DFN6 (2x2) packing information

Figure 46. DFN6 (2 x 2 mm) reel outline



Note: Drawing not in scale

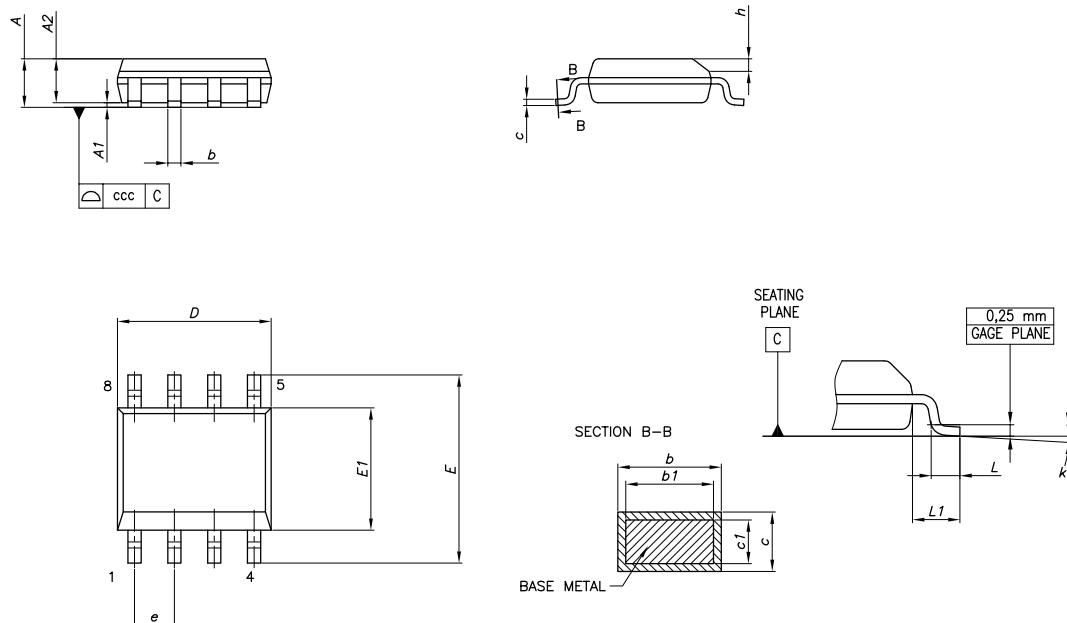
Table 8. DFN6 (2 x 2 mm) tape and reel mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			180
C	12.8		13.2
D	20.2		
N	60		
T			14.4
A0		2.4	
B0		2.4	
K0		1.3	
P0		4	
P		4	

7.5

SO8 package information

Figure 47. SO-8 batwing package outline

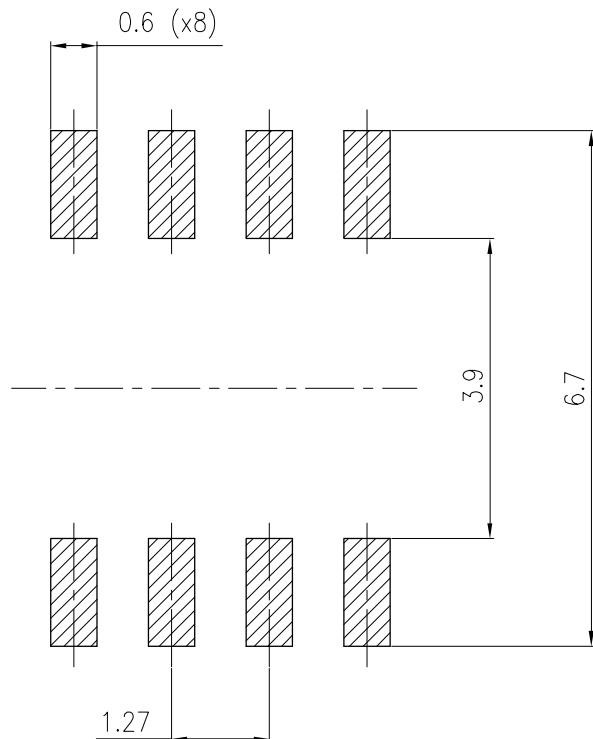


0016023_G

Table 9. SO-8 batwing mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
c	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
k	0°		8°
ccc			0.10

Figure 48. SO-8 batwing recommended footprint



0016023_GU

8

Ordering information

Table 10. Order code

DFN6 (3x3)	DFN6 (2x2)	SO-8 batwing plastic micropackage	Output voltage (V)
LDL212PU12R ⁽¹⁾			1.2
LDL212PU15R			1.5
LDL212PU18R ⁽¹⁾			1.8
LDL212PU25R ⁽¹⁾			2.5
LDL212PU30R ⁽¹⁾			3
	LDL212PV33R	LDL212D33R ⁽¹⁾	3.3
LDL212PU50R			5
LDL212PUR	LDL212PVR	LDL212DR	Adjustable

1. Available on request.

Revision history

Table 11. Document revision history

Date	Revision	Changes
02-Mar-2016	1	Initial release.
19-Sep-2016	2	Updated Table 3: "Thermal data" and Section 5: "Electrical characteristics". Minor text changes.
17-Sep-2018	3	Added: GND pin name in Table 1. Pin description and new order code LDL212D33R in Table 10. Order code .

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